國立彰化師範大學

機電工程學系碩士在職專班畢業條件表暨課程架構表 (106學年度入學學生適用)

National Changhua University of Education

Graduation Requirements and Course Structure for Master's Program of Mechatronics Engineering (Applicable for students in 106 academic year)

列印日期(Print Date:2025/11/10)

一.系必修課程

I.Department Required Courses

課程名稱 Course Name	學分/學時 Credit(s)/ Hour(s)	年級 Grade	學期 Semester
書報討論(一) Seminar I	2/2	1	1
書報討論(二) Seminar II	2/2	1	2
機電專題(一) Mechatronics Project I	2/2	1	2
機電專題(二) Mechatronics Project II	2/2	2	1
論文 Thesis	0/0	2	2
論文指導 Thesis Supervision	4/0	2	2

二.系選修課程

II.Department Elective Courses

課程名稱 Course Name	學分/學時 Credit(s)/ Hour(s)
互聯網系統設計	3/3
Internet System Design	
光電半導體元件	3/3
Optoelectronic Semiconductor Devices	3/3
光電半導體材料與物理	3/3
Optoelectronic Semiconductor Materials and Physics	3/3
光學微影與蝕刻	3/3
Photolithography and Etching	3/3
奈米結構製程	3/3
Nanostructure Fabrication	3/3
科技英文	3/3
English for Science and Technology	3/3
微波積體電路設計與應用	3/3
Microwave Integrated Circuit Design and Applications	3/3
微電子材料與製程	3/3
Microelectronic Matericals and Processes	5/5
微機電技術與實務	3/3
MEMS technology and practice	3/3

微機電製程	3/3
MEMS Processes	
精密機械與光電量測	3/3
Precision Machine Tool and Photoelectric Measurement	
機電產業實務與管理	3/3
Practice and Management of Mechatronic Industry	
應用電子學	3/3
Applied Electronics	
薄膜製程與應用 The flim processes and appilications	3/3
類比積體電路設計與應用	
Analog Integrated Circuit Design and Applications	3/3
PCI 介面電路設計	
PCI Interface Circuitry Design	3/3
工程設計與系統分析	
Engineering Design and System Analysis	3/3
光機系統設計	
Opto-mechanical Systems Design	3/3
有限元素法	
Finite Element Method	3/3
系統設計與動態分析	
System Design and Dynamics	3/3
奈米機電系統	
Nano-Electro-Mechanical Systems	3/3
氣體潤滑理論與應用	
Air Lubrication Theory and Application	3/3
現代控制工程	2 /2
Modern Control Engineering	3/3
結構動態與控制工程	2./2
Dynamics and Control of Structures	3/3
結構設計與振動分析	2 /2
Structural Design and Vibrational Analysis	3/3
雷射加工系統設計	2 /2
Design of the Laser Processing Systems	3/3
電子儀器與量測	2 /2
Electronic Instrument and Measurement	3/3
影像處理與應用	3/3
Image Processing and Application	<i>3/3</i>
數值分析	3/3
Numerical Analysis	<i>3/3</i>
機電動態系統	3/3
Mechatronics Dynamic Systems	5/ 5
半導體產業與技術	3/3
Semiconductor Industry and Technology	5,5
半導體製程設備	3/3
Equipments of Semiconductor Processes	3, 3
平面顯示器技術	3/3
Flat Panel Display Technology	
光電系統設計與應用	3/3
Application and Design of Optical Electronic System	-, -

光學系統設計與應用 Optical System Design and Applications 光機電技術與應用 Opto-Electromachanical Technologies and Applications
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Engineering Statistics and Experimental Design 大陽雷池原理與製程
太陽電池原理與製程
3/3
Principle and Process of Solar Cells
半導體元件 3/3
Semiconductor Devices
自動控制工程 3/3
Automatic Control Engineering
高科技產業與知識管理 3/3
High-Tech Industry and Knowledge Management
智慧型控制系統設計與應用 3/3
Intelligent Control System Design and Applications
ಪ測與量測 3/3
Sensor and Measurement
該測器與介面電路設計與應用 3/3
Design and Application of Sensors Interface Circuits
情密運動控制 3/3
Precise Motion Control
影像處理技術 3/3
Image Processing Technology
機電系統整合設計 3/3
Mechatronics System Integration Design
機電產品可靠度工程分析 3/3
Reliability analysis for mechatronics products

三.先修科目

III.Prerequisite Courses

先修課程	後修課程
Prerequisite Course	Subsequent Course

四.畢業條件

IV.Graduation Requirements

- 1.本班別最低畢業學分為30學分,包含必修12學分、選修18學分,含論文指導4學分,且須通過學位考試。
- 2.凡選修本專班開設科目(不限學期),一律承認為本系畢業學分。
- 3.修課經指導教授同意可選修外系研究所開設科目(不限學期)·至多6 學分(選課前送教授同意表至系辦備查)。
- 4.學生除須修滿應修學分外·同時須符合「機電工程學系碩士學位在職進修專班研究生學位考試程序作業辦法」規定·方具備畢業 資格。
- 5.研究生應於申請學位考試前修習通過於「臺灣學術倫理教育資源中心」(https://ethics.nctu.edu.tw/)網路教學平台之「學術研究倫理教育」課程等相關規定。
- 1.The minimum graduation requirement for this program is 30 credits, including 12 credits of required courses, 18 credits of elective courses, and 4 credits for thesis supervision. Students must also pass the degree examination.
- 2. Any courses taken from this specialized program (regardless of semester) will be recognized as part of the department's graduation credits.
- 3. With the approval of the advisor, students may take up to 6 credits of courses offered by other departments (regardless of semester), provided that the consent form is submitted to the department office for record before enrolling in the
- 4.In addition to completing the required credits, students must also comply with the "Procedures for the Master's Degree Examination of the Executive Master's Program in Mechatronic Engineering" to qualify for graduation.
- 5.Graduate students must complete and pass the "Academic Research Ethics Education" course offered by the Taiwan Academic Ethics Education Resource Center (https://ethics.nctu.edu.tw/) on its online teaching platform before applying for the degree examination, among other related requirements.